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ATENTS ONLY	
o the Honorable Commissioner of Patents and Trademarks. Please record the	attached original documents or copy thereof.
Name of conveying party(ies):  Donald C. Abbott Michael E. Mitchell Paul R. Moehle  dditional name(s) attached? Yes X No	2. Name and Address of receiving party(ies): Name: Texas Instruments Incorporated Address: P.O. Box 655474 M/S 3999 City: Dallas State: TX Zip: 75265 Additional name(s) attached?YesX_No
Nature of Conveyance:	
_x_ Assignment Merger Security Agreement Change of Name	
Other	
Execution Date July 17, 2000	
Application number(s) or patent number(s).	1900080
_x_ This document is being filed together with a new applicate	ion.
Execution date of the application: July 17, 2000	
: "Preplating of Semiconductor Small Outline	No-Lead Leadframes"
Docket No.: TI-30788  Patent Application No.(s)	B. Patent No.(s)
Additional numbers attached?Yesx_No	Additional numbers attached? Yes x No
Name and address of party to whom correspondence concerning	6. Number of applications and patents involved: I
document should be mailed:	7. Amount of fee enclosed or authorized to be charge: \$40
Name: Gary C. Honeycutt Godwin White Gruber 801 E. Campbell Rd. Suite 655 Richardson	8. Deposit account number (Attach two copies of this form if paying by deposit account): 20-0668
State: TX Zip: 75081	
DO NOT USE THIS SPACE	
Statement and signature.  To the best of my knowledge and belief, the foregoing information is  Gary C. Honeycutt	true and correct and any attached copy is a true copy of the original document.  Date: July 6, 2001
Statement and signature.  To the best of my knowledge and belief, the foregoing information is  Ory C. Hayreltt	

PATENT REEL: 011982 FRAME: 0307

## **ASSIGNMENT**

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made, the said application having been executed on the date set forth below; and

WHEREAS, TEXAS INSTRUMENTS INCORPORATED, a corporation organized and existing under the laws of the State of Delaware, with a place of business at 7839 Churchill Way, MS 3999, Dallas, Texas 75251, is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign to the said TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my entire right, title and interest in and to the said invention and in to the said application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner of Patents and Trademarks to issue all patents for said invention, or patent resulting therefrom, insofar as my interest is concerned, to the said TEXAS INSTRUMENTS INCORPORATED, as assignee of my entire right, title and interest.

I also hereby sell and assign to TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

I hereby further agree that I will communicate to said TEXAS INSTRUMENTS INCORPORATED, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said TEXAS INSTRUMENTS INCORPORATED, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

IN WITNESS WHEREOF, I hereunto set hand and seal this day and year;

TITLE OF INVENTION	Preplating	of Semiconductor Smal. Leadframes	l Outline No-Lead
SIGNATURE OF INVENTOR AND NAME	Donald C. Abbott	Me DE Mitchell  Michael E. Mitchell	A Faul Moll
DATE OF SIGNATURE	× 7/17/00	* 7/17/00	. 7/17/00
RESIDENCE (City, State)	Norton, Massachusetts	Plaistow, New Hampshire	Seekonk, Massachusetts
DATE APPLICATION EXECUTED	. 7/17/00	* 7/14/00	x 7/,7/0°

After recording Assignment, please return to:

RECORDED: 07/06/2001

Gary C. Honeycutt
Texas Instruments Incorporated
P.O. Box 655474, MS 3999
Dallas, TX 75265

PATENT REEL: 011982 FRAME: 0308